



MSP430FG4260 Device Erratasheet

1 Functional Errata Revision History

Errata impacting device's operation, function or parametrics.

 \checkmark The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev A
DAC2	\checkmark
DAC3	\checkmark
FLL3	\checkmark
LCDA1	\checkmark
LCDA2	\checkmark
LCDA3	\checkmark
LCDA5	✓
LCDA7	\checkmark
PORT6	\checkmark
SDA3	\checkmark
SDA6	\checkmark
SDA7	\checkmark
TA12	\checkmark
TA16	\checkmark
TA21	\checkmark
TAB22	\checkmark
WDG2	\checkmark

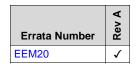
2 Preprogrammed Software Errata Revision History

Errata impacting pre-programmed software into the silicon by Texas Instruments. ✓ The check mark indicates that the issue is present in the specified revision. The device doesn't have Software in ROM errata.

3 Debug only Errata Revision History

Errata only impacting debug operation.

 \checkmark The check mark indicates that the issue is present in the specified revision.





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4 Fixed by Compiler Errata Revision History

Errata completely resolved by compiler workaround. Refer to specific erratum for IDE and compiler versions with workaround.

✓ The check mark indicates that the issue is present in the specified revision.

Errata Number	Rev A
CPU4	<

Refer to the following MSP430 compiler documentation for more details about the CPU bugs workarounds.

TI MSP430 Compiler Tools (Code Composer Studio IDE)

- MSP430 Optimizing C/C++ Compiler: Check the --silicon_errata option
- MSP430 Assembly Language Tools

MSP430 GNU Compiler (MSP430-GCC)

- MSP430 GCC Options: Check -msilicon-errata= and -msilicon-errata-warn= options
- MSP430 GCC User's Guide

IAR Embedded Workbench

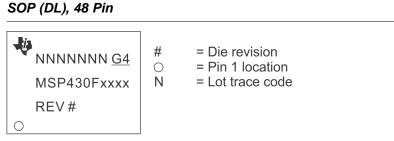
• IAR workarounds for msp430 hardware issues

TEXAS INSTRUMENTS

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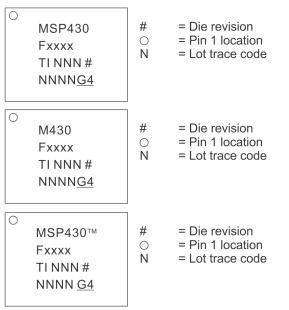
5 Package Markings





RGZ48

QFN (RGZ), 48 Pin



NOTE: Package marking with "TM" applies only to devices released after 2011.



Detailed Bug Description

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6 Detailed Bug Description

CPU4	CPU Module		
Category	Compiler-Fixed		
Function	PUSH #4, PUSH #8CPU4 - Bug		
Description	The single operand instruction PUSH cannot use the internal constants (CG) 4 and 8. The other internal constants (0, 1, 2, -1) can be used. The number of clock cycles is different:		
	PUSH #CG uses address mode 00, requiring 3 cycles, 1 word instruction		
	PUSH #4/#8 uses address mode 11, requiring 5 cycles, 2 word instruction		

Workaround

Refer to the table below for compiler-specific fix implementation information.

IDE/Compiler	Version Number	Notes
IAR Embedded Workbench	IAR EW430 v2.x until v6.20	User is required to add the compiler flag option below. hw_workaround=CPU4
IAR Embedded Workbench	IAR EW430 v6.20 or later	Workaround is automatically enabled
TI MSP430 Compiler Tools (Code Composer Studio)	v1.1 or later	
MSP430 GNU Compiler (MSP430-GCC)	MSP430-GCC 4.9 build 167 or later	

DAC2 DAC12 Module

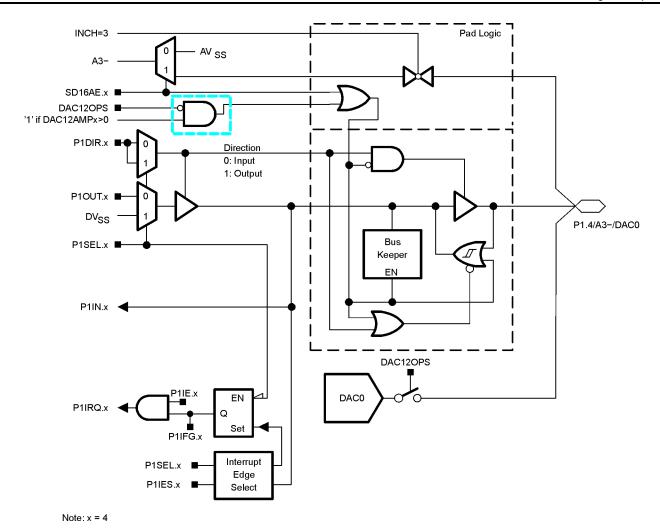
Category Functional

Function P1.4 GPIO function is not disabled when P1.4 = DAC0 output

Description The DAC12OPS control bit used to automatically disable the P1.4 I/O logic is inverted as shown in the figure below. When DAC12 is enabled (DAC12AMPx > 0) and DAC12OPS=0, the port I/O for P1.4 will be disabled. Setting DAC12OPS = 1 to connect the DAC12 output to P1.4 will erroneously enable the port GPIO logic.



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Workaround The P1.4 I/O logic should be disabled when the DAC12 is enabled using the SD16AE.4 analog enable bit. SD16AE.4=1 will disable the P1.4 I/O logic. The A3 SD16_A analog input cannot be used under this condition.

DAC3	DAC12 Module
Category	Functional
Function	Port P1.4 can not be used if DAC12 is internally enabled.
Description	When DAC12 is enabled (DAC12AMPx > 0) and internal use is selected (DAC12OPS=0), the P1.4 digital I/O functionality is disabled. See also: DAC2 bug description.
Workaround	None
EEM20	EEM Module
Category	Debug



Detailed Bug Description	www.ti.com
Function	Debugger might clear interrupt flags
Description	During debugging read-sensitive interrupt flags might be cleared as soon as the debugger stops. This is valid in both single-stepping and free run modes.
Workaround	None.
FLL3	FLL+ Module
Category	Functional
Function	FLLDx = 11 for /8 may generate an unstable MCLK frequency
Description	When setting the FLL to higher frequencies using $FLLDx = 11$ (/8) the output frequency of the FLL may have a larger frequency variation (e.g. averaged over 2sec) as well as a lower average output frequency than expected when compared to the other FLLDx bit settings.
Workaround	None
LCDA1	LCD_A Module
Category	Functional
Function	High voltage on LCD_A pins.
Description	When static LCD mode is selected, the charge pump does not work correctly. The feedback loop within the charge pump is switched off. This can result in high voltages on LCD_A segment and common pins.
	WARNING: Using the charge pump when static mode is selected may cause permanent damage to the MSP430 device and/or the LCD.
Workaround	None
LCDA2	LCD_A Module
Category	Functional
Function	Floating segment S5
Description	Dedicated LCD segment S5 is floating when LCD_A is disabled: LCDON = 0. In this case S5 should be connected to ground.
Workaround	None
LCDA3	LCD_A Module
Category	Functional
Function	Charge pump voltage
Description	The charge pump output voltage has an offset of approximately -200 mV. This reduces the LCD voltage levels specified in the datasheet for LCD_A by the same amount and should be accounted for when selecting a charge pump voltage. See actual values

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below:

LCD_A

	PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	UNIT		
V _{CC(LCD)}	Supply voltage	Charge pump enabled (LCDCPEN = 1; VLCDx > 0000)		2.2		3.6	V		
C _{LCD}	Capacitor on LCDCAP (see Note 1)	Charge pump enabled (LCDCPEN = 1; VLCDx > 0000)		4.7			μF		
I _{CC(LCD)}	Average supply current (see Note 2)	$\begin{array}{l} V_{LCD(typ)}{=}3V; \ LCDCPEN = 1; \\ VLCDx{=}\ 1000, \ all \ segments \ on \\ f_{LCD}{=}\ \ f_{ACLK}/32 \\ no \ LCD \ connected \ (see \ Note \ 2) \\ T_{A} = 25^{\circ}C \end{array}$	2.2 V		3.8		μA		
f _{LCD}	LCD frequency					1.1	kHz		
		VLCDx = 0000			VCC				
		VLCDx = 0001			2.50				
		VLCDx = 0010			2.56				
V _{LCD} LCE		VLCDx = 0011			2.61		V		
		VLCDx = 0100			2.67				
		VLCDx = 0101			2.72				
		VLCDx = 0110			2.78	Ĭ			
	LCD voltage	VLCDx = 0111		li –	2.83				
		VLCDx = 1000			2.89	i			
		VLCDx = 1001		1	2.94				
		VLCDx = 1010			3.00	i			
		VLCDx = 1011			3.05				
		VLCDx = 1100			3.11				
		VLCDx = 1101			3.16				
		VLCDx = 1110			3.22				
		VLCDx = 1111		3.12	3.27	3.42			
R _{LCD}	LCD driver output impedance	V _{LCD} = 3V; LCDCPEN = 1; VLCDx = 1000, I _{LOAD} = ±10μA	2.2 V			10	kΩ		

NOTES: 1. Enabling the internal charge pump with an external capacitor smaller than the minimum specified might damage the device. 2. Connecting an actual display will increase the current consumption depending on the size of the LCD.

Workaround	None
LCDA5	LCD_A Module
Category	Functional
Function	Wrong cycle time for first cycle of COMx/Sx signals
Description	The time of the first cycle of COMx/Sx signals after enabling the LCD_A module is only half of the selected value. All following cycles are correct
Workaround	Not required, because it does not influence the LCD function.
LCDA7	LCD_A Module
Category	Functional
Function	Higher current consumption when using shared LCD ports as fast toggling outputs



Detailed Bug Description	www.ti.com
Description	If a shared LCD pin (segment or com line) is used as digital fast toggling output (f>10kHz) and the VLCD is >0V (BG enabled) the device current consumption increases with higher toggling frequencies.
Workaround	1. Do not use shared LCD pins as fast toggling outputs if an LCD is used.
	2. Reduce the toggle frequency of the shared pin to <10kHz.
PORT6	PORT Module
Category	Functional
Function	P2.0 module function
Description	In addition to GPIO and LCD functionality, P2.0 also has Timer_A3 module output capability. When P2SEL.0 = 1 and P2DIR.0 = 1, P2.0 becomes a TA2 output.
LCDS1 Segment S DV _S P2DIR. P2OUT: Module X OU P2SEL. P2IN. Module X I P2IRQ.	P2/E.X EN

	CONTROL BITS / SIGNALS				ALS	
PIN NAME (P2.X)	X	FUNCTION	P2DIR.x P2SEL.x LCDS12			
P2.0/S13/TA2		P2.0 Input/Output	0/1	0	0	
1 2.0/010/172	0	N/A	0	1	0	
	ľ	Timer_A3.TA2 S13	1 X	1 X	0	
Workaround	N	/A				
SDA3	S	D16_A Module				
Category	Fu	unctional				
Function	Tł	ne interrupt delay function car	result in incorrect	conversion data		
Description	The interrupt delay operation can result in incorrect conversion data when SD16INTDLYx = 01, 10 or 11.					
Workaround	Use SD16INTDLYx = 00 setting (interrupt generated after fourth conversion). This applies to the first conversion in Continuous mode and to each conversion in Single mode.					
SDA6	SD16_A Module					
Category	Functional					
Function	SD16CCTL0 write leads to unexpected results from SD16_A.					
Description	 No write attempt should be made to the register address 0x00B8 since it might lead malfunctioning of SD16A. 				ince it might lead t	
	 Bit-0 and bit-15 of register SD16CCTL0 should not be set as it might lead to unexpected results from the SD16A. 					
Workaround	N	one				
SDA7	S	D16_A Module				
Category	Fu	unctional				
Function	R	educed performance when inp	out buffer is enable	d.		
Description	The SD16_A performance is degraded if the high-impedance input buffer is enabled (SD16CCTLx.SD16BUFx > 0) and the analog input voltage is in the range of AVSS to AVSS+0.2V. Avoid analog input voltages in this range when the high-impedance input buffer is enabled.					
Workaround	N	one				
TA12	Т	IMER_A Module				
Category	Functional					

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Function	Interrupt is lost (slow ACLK)
Description	Timer_A counter is running with slow clock (external TACLK or ACLK)compared to MCLK. The compare mode is selected for the capture/compare channel and the CCRx register is incremented by one with the occurring compare interrupt (if TAR = CCRx). Due to the fast MCLK the CCRx register increment (CCRx = CCRx+1) happens before the Timer_A counter has incremented again. Therefore the next compare interrupt should happen at once with the next Timer_A counter increment (if TAR = CCRx + 1). This interrupt gets lost.
Workaround	Switch capture/compare mode to capture mode before the CCRx register increment. Switch back to compare mode afterwards.
TA16	TIMER_A Module
Category	Functional
Function	First increment of TAR erroneous when $IDx > 00$
Description	The first increment of TAR after any timer clear event (POR/TACLR) happens immediately following the first positive edge of the selected clock source (INCLK, SMCLK, ACLK or TACLK). This is independent of the clock input divider settings (ID0, ID1). All following TAR increments are performed correctly with the selected IDx settings.
Workaround	None
TA21	TIMER_A Module
Category	Functional
Function	TAIFG Flag is erroneously set after Timer A restarts in Up Mode
Description	In Up Mode, the TAIFG flag should only be set when the timer counts from TACCR0 to zero. However, if the Timer A is stopped at TAR = TACCR0, then cleared (TAR=0) by setting the TACLR bit, and finally restarted in Up Mode, the next rising edge of the TACLK will erroneously set the TAIFG flag.
Timer (T Set T/	Timer CCR0-1 SCR0 Oh A 1h A SS A CCR0-1 CCR0 Oh
Set TACCR0 CC	CIFG
Workaround	None.
TAB22	TIMER_A/TIMER_B Module
Category	Functional



www.ti.com	Detailed Bug Description
Function	Timer_A/Timer_B register modification after Watchdog Timer PUC
Description	Unwanted modification of the Timer_A/Timer_B registers TACTL/TBCTL and TAIV/TBIV can occur when a PUC is generated by the Watchdog Timer(WDT) in Watchdog mode and any Timer_A/Timer_B counter register TACCRx/TBCCRx is incremented/decremented (Timer_A/Timer_B does not need to be running).
Workaround	Initialize TACTL/TBCTL register after the reset occurs using a MOV instruction (BIS/BIC may not fully initialize the register). TAIV/TBIV is automatically cleared following this initialization.
	Example code:
	MOV.W #VAL, &TACTL
	or
	MOV.W #VAL, &TBCTL
	Where, VAL=0, if Timer is not used in application otherwise, user defined per desired function.
WDG2	WDT Module
Category	Functional
Function	Incorrectly accessing a flash control register

If a key violation is caused by incorrectly accessing a flash control register, the watchdog interrupt flag is set in addition to the expected PUC. Description

Workaround None Document Revision History

7 Document Revision History

Changes from family erratasheet to device specific erratasheet.

- 1. Errata SDA1 was removed
- 2. Errata SDA6 was added
- 3. Errata TAB22 was added
- 4. Errata SDA7 was added
- 5. Errata LCDA7 was added
- 6. Errata LCDA5 was added
- 7. RGZ48 package markings have been updated

Changes from device specific erratasheet to document Revision A.

1. Errata EEM20 was added to the errata documentation.

Changes from document Revision A to Revision B.

1. Errata TA21 was added to the errata documentation.

Changes from document Revision B to Revision C.

- 1. Package Markings section was updated.
- Changes from document Revision C to Revision D.
- 1. TA21 Description was updated.

Changes from document Revision D to Revision E.

- 1. Function for CPU4 was updated.
- 2. Workaround for CPU4 was updated.

Changes from document Revision E to Revision F.

- 1. Erratasheet format update.
- 2. Added errata category field to "Detailed bug description" section



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